Heater Component Modal Analysis of Electronic Gun under High Temperature Condition

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Keywords: Heater component; Modal; Electric gun.

Abstract. This paper calculates thermal-structural coupling analysis of the heater component considering thermal radiation and heat conduction. We get the heater components steady temperature field and stress distribution. The thermal stress is taken as prestressed force and finite element analysis is used to obtain vibration models. The corresponding modal frequency and modal vibration mode are obtained by simulation analysis and the results provide beneficial references for solving the problem of anti vibration reliability under high temperature.

INTRODUCTION

As the heart of weapon, Traveling Wave Tubes (TWT) is widely used in radar, navigation and communication systems. In order to improve the performance and quality of TWT, many scholars and research institutions do their research about the status and progress of TWT reliability of thermal design, vibration reliability. Electron gun is the key component of TWT, and heater component in electron gun is prone to failure under the condition of high temperature and vibration. According to the statistics, heater component fracture occupies more than sixty percent of electron gun failure.

STEADY THERMAL STRESS ANALYSIS

The high temperature, produced during electronic gun working, results to the thermal-stress of the components, and has effects to the parameters and lifetime of the gun. Electron gun often sustains the effect of mechanical shock and vibration, and heater components will break under the effect of temperature and vibration [3]. According to the statistics, heater component fracture occupies more than sixty percent of electron gun failure.
Thermal balance equation Eq.(1) shows that the required heat of heating up object should be balanced against heat introduced into body and heat generated within object.

\[
\rho c \frac{\partial T}{\partial t} - \frac{\partial}{\partial x} \left[ k_x \frac{\partial T}{\partial x} \right] - \frac{\partial}{\partial y} \left[ k_y \frac{\partial T}{\partial y} \right] - \frac{\partial}{\partial z} \left[ k_z \frac{\partial T}{\partial z} \right] - \rho Q = 0
\]  

(1)

In the equation, \(T(x,y,z,t)\) expresses temperature field, \(\rho\) expresses material density, \(c\) expresses failure rate function, \(t\) expresses time, \(k_x, k_y, k_z\) expresses coefficient of heat conduction, \(Q\) expresses heat source density.

Before the calculation between planar radiation heat energy, the shape factor \(F_{ij}\) should be considered, and Radiant energy which is shown in Fig.2 is applied from a plane \(i\) to another plane \(j\), \(A_i, A_j\) expresses area of plane.

Then Eq.(2) can be obtained as follows:

\[
F_{ij} = \int_A \int_{A_j} \frac{\cos \theta_i \cos \theta_j}{\pi r^2} d(A_j) \frac{\partial T}{\partial A_i} d(A_i)
\]  

(2)

Cathode and the outer surface of cathode, heat shield tube and the inner surface of controller are defined as another radiation groups. Other component temperature is low, and heat transfers mainly by heat conduction, so their thermal radiations can be ignored. Thermal analysis entity unit SOLID90 is used in the steady state of heat conduction Temperature field distribution of electron gun is showed in Fig.3(a). Base on temperature field results, thermal stress is also calculated by changing thermal elements into structural elements. Structural stress finite element cloud of electron gun are showed in Fig.3(b).
MODAL ANALYSIS

The thermal stress is taken as prestressed force, then, natural frequencies and vibration mode can be obtained by modal analysis. The structure of the whole dynamic balance equation can be expressed as Eq.(3).

\[
[M][\ddot{u}] + [C][\dot{u}] + [K][u] = 0
\]  

(3)

In the equation, \([M]\) expresses mass matrix, \([C]\) expresses damp matrix, \([K]\) expresses stiffness matrix, \([\ddot{u}]\) expresses note acceleration vector, \([\dot{u}]\) expresses note velocity vector, \([u]\) expresses note displacement vector. In order to keep precision and speed of calculation, modal calculation adopts lanczos method and invokes sparse matrix equation solver. Because concerned acceleration power spectrum ranges from 10Hz to 2000Hz, so we only need to calculate and expand modal in this range. The first modal vibration mode and the second modal vibration mode are showed in Fig.4(a,b).

CONCLUSION

First, this paper calculates thermal-structural coupling analysis of electron gun by use of ANSYS, and the result Fig.3(a) show that the temperature of the heater component after reaching steady state is about 1324°C, the cathode temperature is about 1067°C. This is similar to the test data, and the difference is mainly due to the actual welding situation in the internal components of the gun which cannot fully reflect in the simulation. Fig.3(b) show that the stress mainly concentrates in the heater terminal of cathode ceramic and the junction between platinum piece and heater. The stress value is about 302MPa.

Second, through putting thermal stress as prestressed force, natural frequencies and vibration
modes can be obtained by modal analysis. Fig.4 shows that the first natural frequency of heater component is about 479Hz and second modal vibration mode is about 527Hz. The max mode of vibration amplitude occurs the junction between platinum piece and heater, and the junction is the most dangerous place prone to breakage. The results provide beneficial references for solving the problem of anti vibration reliability under high temperature.

ACKNOWLEDGMENTS

This work was financially supported by the Distinguished Young Scientist Program of Guangdong Province (2015A030306002), National Natural Science Foundation of China (51505089), Natural Science Foundation of Guangdong Province (2016A030313672) and Pearl River S&T Nova Program of Guangzhou (2014J2200086).

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